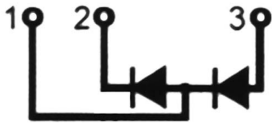
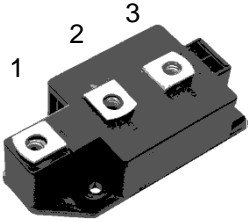


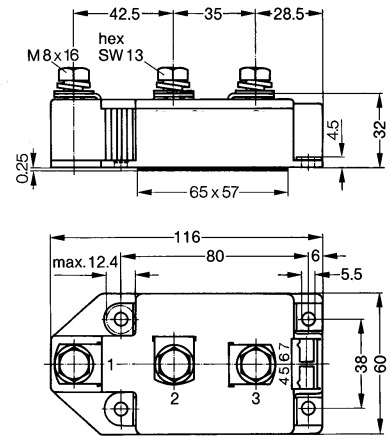
# SDD320

## Diode-Diode Modules



Type	$V_{RSM}$ V	$V_{RRM}$ V
SDD320N08	900	800
SDD320N12	1300	1200
SDD320N14	1500	1400
SDD320N16	1700	1600
SDD320N18	1900	1800

### Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
$I_{FRMS}$ $I_{FAVM}$	$T_{VJ}=T_{VJM}$ $T_C=100^{\circ}C$ ; 180° sine	480 320	A
$I_{FSM}$	$T_{VJ}=45^{\circ}C$ $V_R=0$ t=10ms (50Hz), sine t=8.3ms (60Hz), sine	11500 12200	A
	$T_{VJ}=T_{VJM}$ $V_R=0$ t=10ms(50Hz), sine t=8.3ms(60Hz), sine	9600 10200	
$\int i^2 dt$	$T_{VJ}=45^{\circ}C$ $V_R=0$ t=10ms (50Hz), sine t=8.3ms (60Hz), sine	662000 620000	$A^2s$
	$T_{VJ}=T_{VJM}$ $V_R=0$ t=10ms(50Hz), sine t=8.3ms(60Hz), sine	460000 430000	
$T_{VJ}$ $T_{VJM}$ $T_{stg}$		-40...+150 150 -40...+125	$^{\circ}C$
$V_{ISOL}$	50/60Hz, RMS $I_{ISOL} \leq 1mA$ t=1min t=1s	3000 3600	V~
$M_d$	Mounting torque (M5) Terminal connection torque (M8)	2.5-5/22-24 12-15/106-132	Nm/lb.in.
Weight	Typical including screws	320	g

# SDD320

## Diode-Diode Modules

Symbol	Test Conditions	Characteristic Values	Unit
<b>I<sub>RRM</sub></b>	$T_{VJ}=T_{VJM}; V_R=V_{RRM}$	40	mA
<b>V<sub>F</sub></b>	$I_F=600A; T_{VJ}=25^{\circ}C$	1.2	V
<b>V<sub>TO</sub></b>	For power-loss calculations only	0.75	V
<b>r<sub>T</sub></b>	$T_{VJ}=T_{VJM}$	0.63	m $\Omega$
<b>Q<sub>S</sub></b>	$T_{VJ}=125^{\circ}C; I_F=400A; -di/dt=50A/us$	760	$\mu C$
<b>I<sub>RM</sub></b>		275	A
<b>R<sub>thJC</sub></b>	per diode; DC current per module	0.129 0.065	K/W
<b>R<sub>thJK</sub></b>	per diode; DC current per module	0.169 0.0845	K/W
<b>ds</b>	Creepage distance on surface	12.7	mm
<b>dA</b>	Strike distance through air	9.6	mm
<b>a</b>	Maximum allowable acceleration	50	m/s <sup>2</sup>

### FEATURES

- \* International standard package
- \* Direct copper bonded Al<sub>2</sub>O<sub>3</sub>-ceramic base plate
- \* Planar passivated chips
- \* Isolation voltage 3600 V~

### APPLICATIONS

- \* Supplies for DC power equipment
- \* DC supply for PWM inverter
- \* Field supply for DC motors
- \* Battery DC power supplies

### ADVANTAGES

- \* Space and weight savings
- \* Simple mounting
- \* Improved temperature and power cycling
- \* Reduced protection circuits

# SDD320

## Diode-Diode Modules

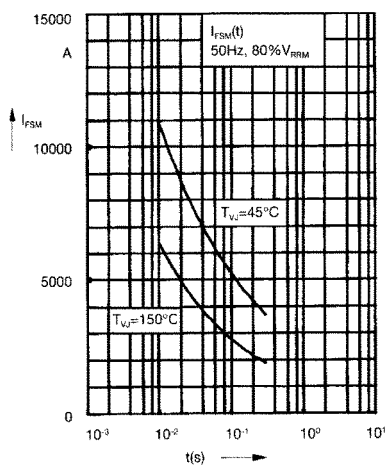


Fig. 1 Surge overload current  
 $I_{FSM}$ : Crest value,  $t$ : duration

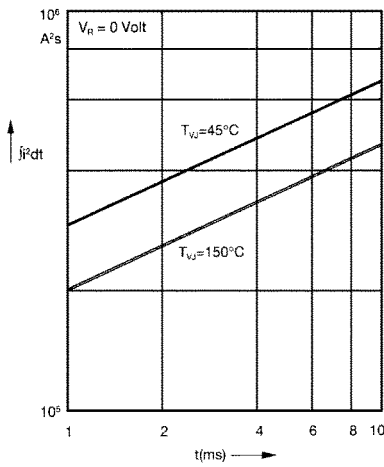


Fig. 2  $\int j^2 dt$  versus time (1-10 ms)

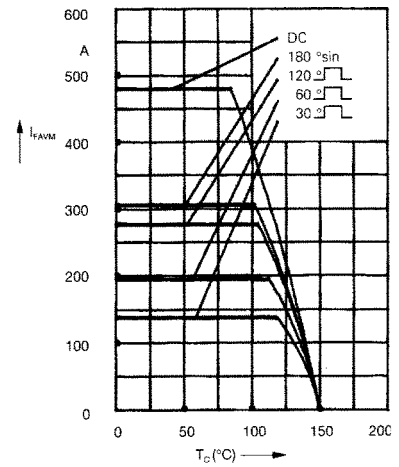


Fig. 2a Maximum forward current at case temperature

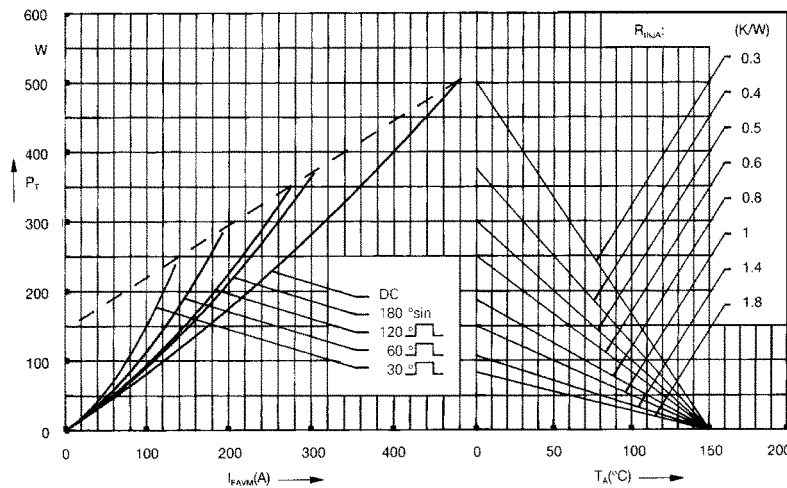


Fig. 3 Power dissipation versus forward current and ambient temperature (per diode)

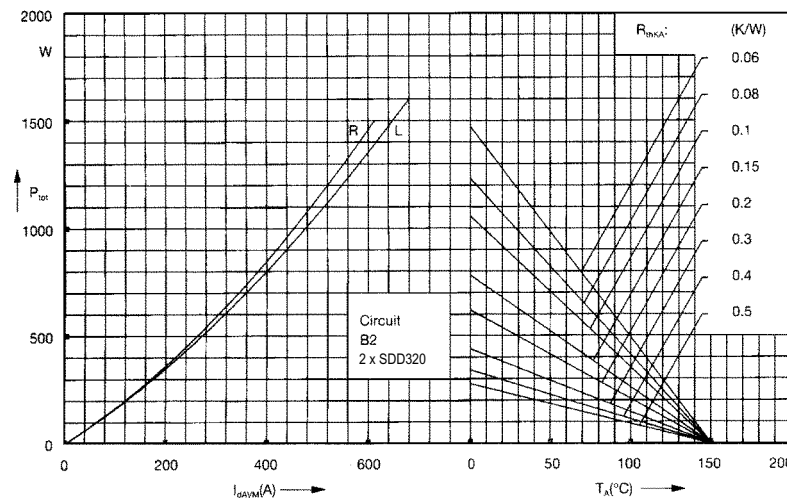


Fig. 4 Single phase rectifier bridge:  
Power dissipation versus direct output current and ambient temperature  
R = resistive load  
L = inductive load

# SDD320

## Diode-Diode Modules

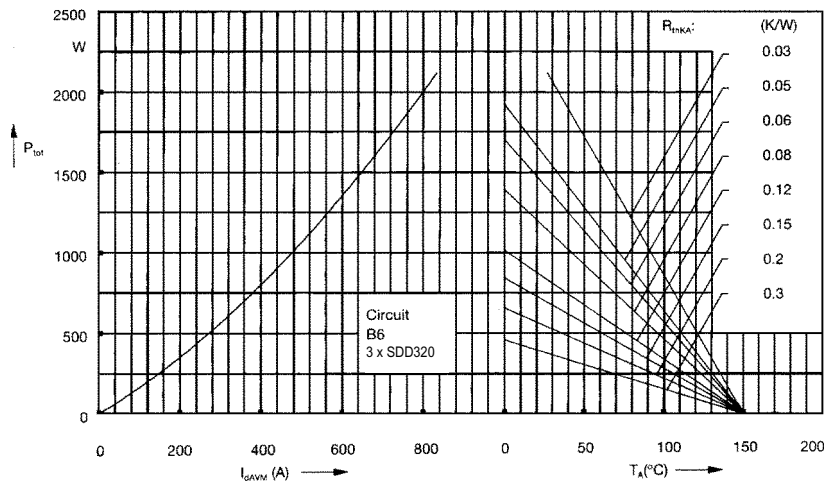


Fig. 5 Three phase rectifier bridge:  
Power dissipation versus direct  
output current and ambient  
temperature

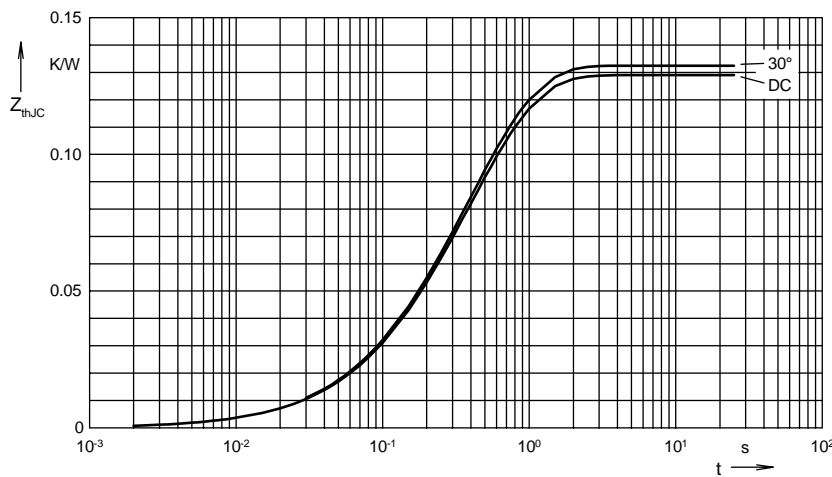


Fig. 6 Transient thermal impedance  
junction to case (per diode)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ (K/W)
DC	0.129
180°C	0.131
120°C	0.132
60°C	0.132
30°C	0.133

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0035	0.0099
2	0.0165	0.168
3	0.1091	0.456

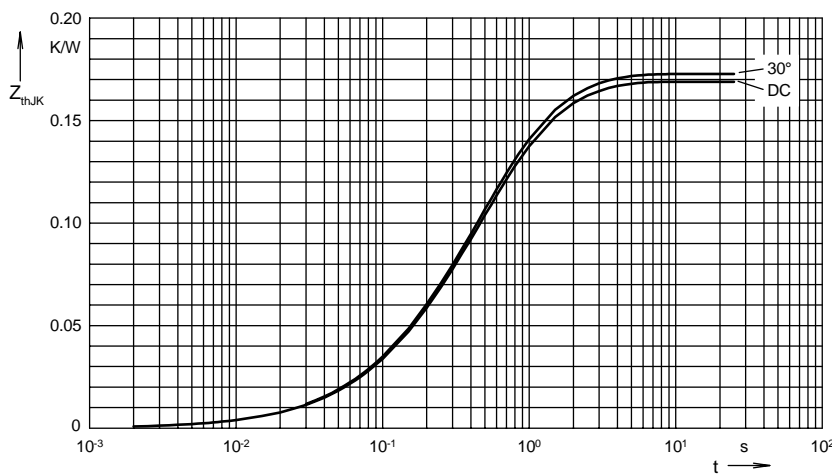


Fig. 7 Transient thermal impedance  
junction to heatsink (per diode)

$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ (K/W)
DC	0.169
180°C	0.171
120°C	0.172
60°C	0.172
30°C	0.173

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0035	0.0099
2	0.0165	0.168
3	0.1091	0.456
4	0.04	1.36